

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (mA)
40	3	0.53	0.4

Description and Applications

The SBR3A40SAF is a single rectifier packaged in the low profile SMAF package. Providing low VF and excellent high temperature stability this device is ideal for use in general rectification applications such as:

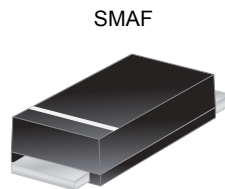
- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Patented SBR technology provides an avalanche capability five times larger than Schottky diodes, ensuring more rugged and reliable end applications.
- Lower reverse leakage ensuring greater stability at higher temperatures
- Low forward voltage (V_F) minimizes conduction losses and improving efficiency.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 Ⓜ
- Polarity: Cathode Band
- Weight: 0.064 grams (approximate)



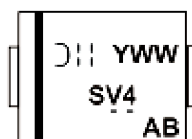
Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR3A40SAF-13	SMAF	10000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



SV4 = Product Type Marking Code
 Ⓜ = Manufacturers' code marking
 YWW = Date Code Marking
 Y = Last digit of year (ex: 7 for 2007)
 WW = Week code (01 to 53)
 AB = Foundry and Assembly Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current (See Figure 1)	I _O	3.0	A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	A

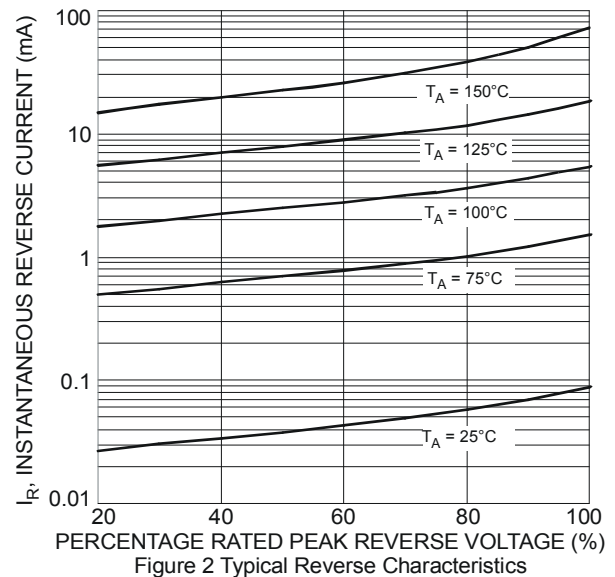
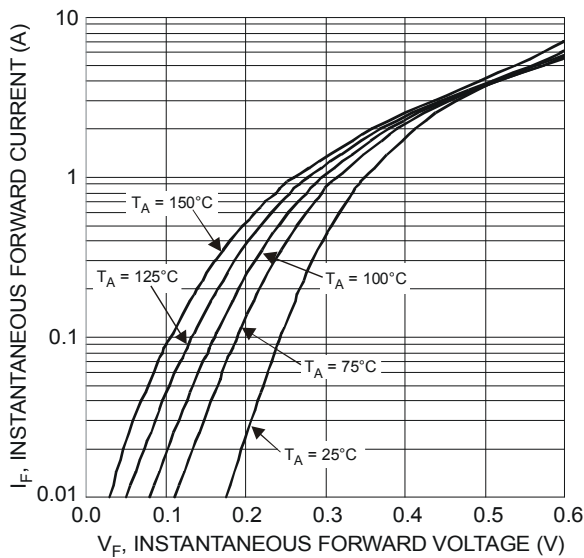
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Case (Note 5)	R _{θJC}	15	°C/W
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	85	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.46	0.53	V	I _F = 3.0A, T _J = +25°C
Leakage Current (Note 6)	I _R	—	—	0.4	mA	V _R = 40V, T _J = +25°C
		—	—	80	mA	V _R = 40V, T _J = +125°C

Notes: 5. Device mounted on FR-4 substate, 1**1", 2oz, single-sided, PC boards with 0.1**0.15" copper pad.
6. Short duration pulse test used to minimize self-heating effect.



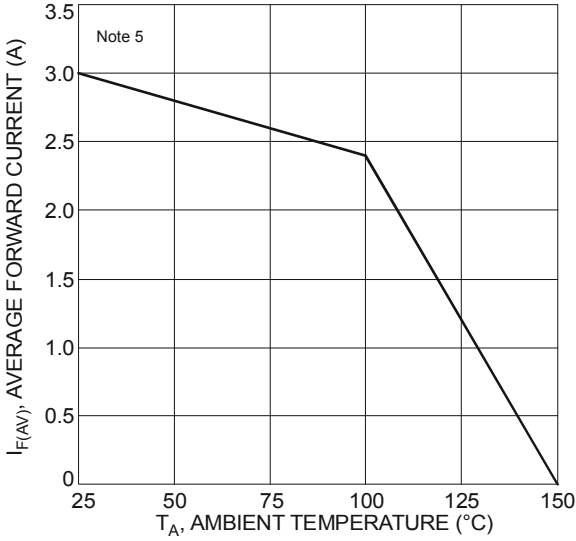


Figure 3 Forward Current Derating Curve

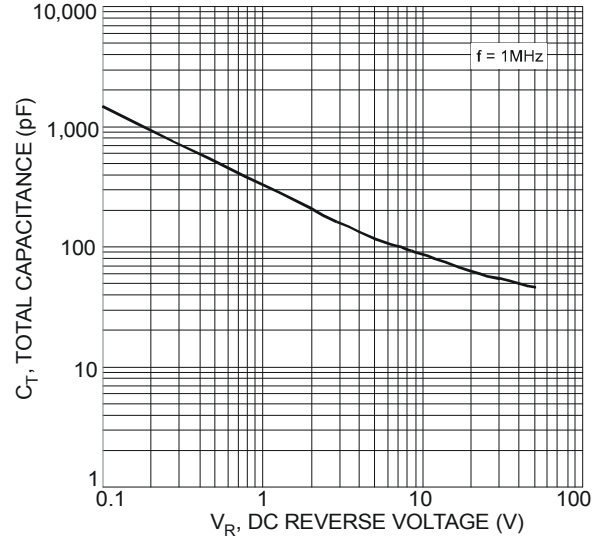
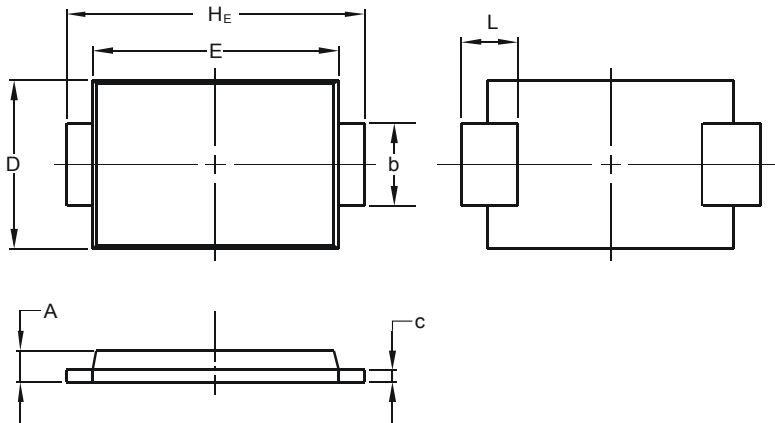


Figure 4 Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

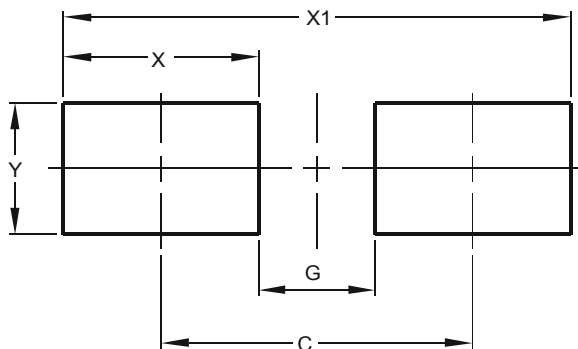
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SMAF		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
H _E	4.80	5.60
L	0.50	1.50
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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